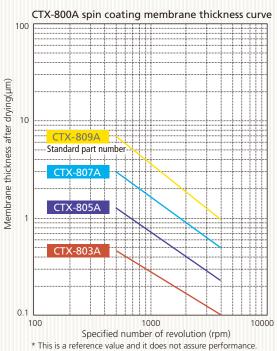
Coating characteristics of CYTOP

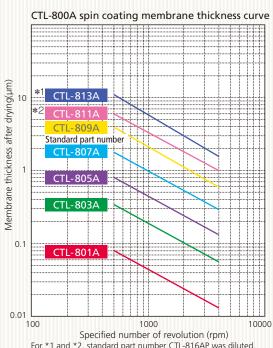
Precautions for handling

Please be sure to read MSDS before using this product to ensure safe handling.

Example of spin coating (CTX-809A type, CTL-800A type)

- (1) Coating conditions
- Spin condition: 500 rpm x 5 sec. -> Specified number of revolution x 20 sec.
- Baking condition: 180 to 200°C x 30 to 60 min.
- Substrate: Silicon wafer (150mm in diameter (6 inches))
- Membrane thickness measurement: ULVAC "DEKTAK"
- (2) Diagram showing relation between spinning speed and membrane thickness after drying





specified number of revolution (pm)

specified number of revolution (pm)

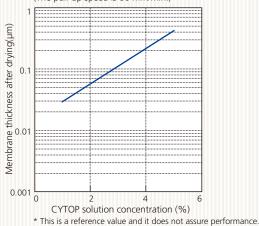
specified number of revolution (pm)

For *1 and *2, standard part number CTL-816AP was diluted.

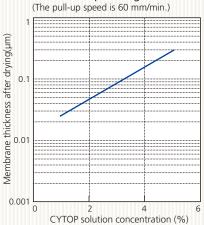
* This is a reference value and it does not assure performance.

2 Example of dip coating (CTX-100AE type, CTL-100AE type)

CTX-100AE dip coating membrane thickness curve (The pull-up speed is 60 mm/min.)



CTL-100AE dip coating membrane thickness curve



* This is a reference value and it does not assure performance.



